## 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

#### **General Description**

The MAX15095 family of devices is an integrated solution for hot-swap applications requiring the safe insertion and removal of circuit line cards from a live backplane. They can also be used as electronics circuit breakers for hard drives, solid-state drives, and fans. The devices integrate a hot-swap controller (10.6m $\Omega$  typ) power MOSFET, and an electronic circuit-breaker protection in a single package.

The devices are designed for protection of 2.7V to 18V supply voltages. These devices implement a foldback current limit during startup to control inrush current, lowering di/dt and keeping the MOSFET operating under safe operating area (SOA) conditions. After the startup cycle is complete, on-chip comparators provide VariableSpeed/BiLevel™ protection against short-circuit and overcurrent faults, and immunity against system noise and load transients. The load is disconnected in the event of a fault condition. The devices are factory calibrated to deliver accurate overcurrent protection with ±10% accuracy. During a fault condition, PG goes low and the devices can latch off (MAX15095) or automatic retry (MAX15095A); the output can also be discharged after a fault event (MAX15095D).

The devices feature an IN-to-OUT short-circuit detection before startup. The devices provide a power-MOSFET GATE pin to program the slew rate during startup by adding an external capacitor. The devices have an under-voltage/overvoltage input pin (UVOV) that can detect an undervoltage/overvoltage fault and disconnect the IN from the OUT. Additional features include internal overtemperature protection and a power-good output (PG).

The devices are available in a 12-pin, 2.5mm x 2.5mm FC2QFN package and are rated over a -40°C to +105°C extended temperature range.

#### **Benefits and Features**

- Integration Reduces Solution Size for Blade Servers and Other Space-Constrained Designs
  - Integrated 10.6mΩ (typ) Internal Power MOSFET
  - Programmable Overvoltage Protection and Undervoltage-Lockout Threshold
  - Drive-Present Signal Input (PRSNT pin)
  - · Thermal Protection
- Flexibility Enables Use in Many Unique Designs
  - 2.7V to 18V Operating Voltage Range
  - Programmable Inrush-Current Control under SOA Operation
  - Adjustable Circuit-Breaker Current/Current-Limit Threshold
  - · Programmable Slew-Rate Control
  - · Variable-Speed Circuit-Breaker Response
  - Latchoff (MAX15095) or Automatic Retry (MAX15095A) Options
- Safety Features Ensure Accurate, Robust Protection
  - · 6.6A (max) Load-Current Capability
  - ±10% Circuit-Breaker Threshold Accuracy
  - IN-to-OUT Short-Circuit Detection
  - Open-Drain PG Output
  - Output Discharge after a Fault Event (MAX15095D Only)
  - Programmable Additional Delay (2µs max) to Fast-Comparator Response Time
  - Enable Input (EN)

#### **Applications**

- Blade Servers
- Server I/O Cards
- RAID Systems
- Disk Drive Power
- Storage Applications
- Industrial Applications

Ordering Information appears at end of data sheet.

VariableSpeed/BiLevel is a trademark of Maxim Integrated Products. Inc.



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### **Absolute Maximum Ratings**

V <sub>CC</sub> to GND		Continuous Power Dissipation (T <sub>A</sub> = +70°C) derate 13.8mW/°C above 70°C	1.105W
PG, PRSNT to GND0.3	3V to +20V	Operating Temperature Range	40°C to +105°C
OUT to GND0.3V to (V	/ <sub>IN</sub> + 0.3V)	Junction Temperature	150°C
GATE to OUT0	.3V to +6V	Storage Temperature Range	60°C to +150°C
EN, UVOV to GND0	.3V to +6V	Soldering Temperature (reflow)	260°C
TIMER, CB to GND0.3V to (V <sub>RE</sub>	<sub>EG</sub> + 0.3V)		
REG to GND0.3V to min (+6V, (V <sub>C</sub>	CC + 0.3V))		

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **Package Information**

PACKAGE TYPE: 12-PIN FC2QFN				
Package Code	F122A2F-1			
Outline Number	21-100198			
Land Pattern Number	90-100073			
THERMAL RESISTANCE, FOUR-LAYER BOARD				
Junction to Ambient (θJ <sub>A</sub> )	72.4°C/W			

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

#### **Electrical Characteristics**

 $(V_{IN} = V_{CC} = 2.7V \text{ to } 18V, T_A = T_J = -40^{\circ}\text{C} \text{ to } +105^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at  $V_{IN} = 12V, R_{CB} = 10.5k\Omega$ , and  $T_A = +25^{\circ}\text{C}$ .) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER SUPPLIES						
V <sub>CC</sub> Operating Range	V <sub>CC</sub>		2.7		18	V
IN Operating Range	V <sub>IN</sub>		2.7		18	V
V Cumbi Cumant		Enable		0.58	0.9	A
V <sub>CC</sub> Supply Current	Icc	Disable		0.590		mA mA
IN Comply Compant		$R_{CB}$ = 41.67kΩ, no load		3.3	3.9	A
IN Supply Current	I <sub>IN</sub>	R <sub>CB</sub> = 10KΩ, no load		1.3	1.8	mA
V <sub>CC</sub> Default Undervoltage Lockout	V <sub>UVLO</sub>	V <sub>CC</sub> rising	2.35	2.5	2.65	V
V <sub>CC</sub> Default Undervoltage-Lockout Hysteresis	V <sub>UVLO_HYS</sub>			0.1		V
REG Regulator Voltage	V <sub>REG</sub>	No load, V <sub>CC</sub> > 4V	3	3.3	3.6	V

# 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

### **Electrical Characteristics (continued)**

 $(V_{IN} = V_{CC} = 2.7V \text{ to } 18V, T_A = T_J = -40^{\circ}\text{C} \text{ to } +105^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at  $V_{IN} = 12V$ ,  $R_{CB} = 10.5k\Omega$ , and  $T_A = +25^{\circ}\text{C}$ .) (Note 1)

UV Turn-On Threshold Hysteresis   Vuy Hys   Vuyov falling   1.199   1.23   1.261   V	PARAMETER	SYMBOL	CON	IDITIONS	MIN	TYP	MAX	UNITS
OV Turn-On Threshold   Voy Th   Vuyor Ising   1.1199   1.23   1.261   V   VV Turn-On Threshold Hysteresis   Voy Hys   Vuyor falling   50   m/V   Vuyor fulling   50   m/V   Vuyor fu	UV Turn-On Threshold	V <sub>UV_TH</sub>	V <sub>UVOV</sub> rising		0.536	0.55	0.564	V
OV Turn-On Threshold Hysteresis         VOV. HYS         Vuvoy falling         50         mV           OVUV Input Leakage Current         ILEAK         Vuvov = VEN = 0V to 5.5V         -1         +1         μA           CURRENT LIMIT           Circuit-Breaker Accuracy (Note 2)         ICB_TH         VIN = 12V         RCB = 41.2kΩ         6         6.6         7.2         A         A           Circuit-Breaker Accuracy (Note 2)         ICB_TH         VIN = 12V         RCB = 41.2kΩ         6         6.6         7.2         A         A           Circuit-Breaker Accuracy (Note 2)         ICB_TH         VIN = 3.3V. TA = 85°C (Note 3.4)         RCB = 46.4kΩ         7.0         7.7         8.4         A           Circuit-Breaker Accuracy Deviation (Note 4)         RCB = 10.5kΩ to 21.5kΩ, compared to nominal current-limit value, VIN = VCC = 2.7V to 12V         -16         -16         +16         -16         +16         -16         -16         +16         %         **         **         **         **         -16         -16         +16         **         **         **         **         **         -16         -16         +16         **         **         **         **         **         **         **         **<	UV Turn-On Threshold Hysteresis	V <sub>UV_HYS</sub>	V <sub>UVOV</sub> falling			50		mV
OVUV Input Leakage Current         I <sub>LEAK</sub> V <sub>UVOV</sub> = V <sub>EN</sub> = 0V to 5.5V         -1         +1         μA           CURRENT LIMIT           V <sub>IN</sub> = 12V         R <sub>CB</sub> = 41.2kΩ         6         6.6         7.2           R <sub>CB</sub> = 10.5kΩ         1.2         1.43         1.66           A Circuit-Breaker Accuracy (Note 2)           V <sub>IN</sub> = 33V, T <sub>A</sub> = 85°C (Note 3, 4)         R <sub>CB</sub> = 41.2kΩ, compared to nominal current-limit value, V <sub>IN</sub> = V <sub>CC</sub> = 2.7V to 12V         -16         +16         +16           Circuit-Breaker Accuracy Deviation (Note 4)         R <sub>CB</sub> = 10.5kΩ to 21.5kΩ, compared to nominal current-limit value, V <sub>IN</sub> = V <sub>CC</sub> = 2.7V to 12V         -16         +16         +16         %           R <sub>CB</sub> = 21.5kΩ to 41.2kΩ, compared to nominal current-limit value value, V <sub>IN</sub> = V <sub>CC</sub> = 2.7V to 12V         -16         +16         +16         %           Slow-Comparator Response Time (Note 5)         t <sub>SCD</sub> 0.6% overcurrent         2.7         ms           -10         +10         +10         +10            -16         +16         +16         +16            -16         +16         +16         +16           -10         +10	OV Turn-On Threshold	V <sub>OV_TH</sub>	V <sub>UVOV</sub> rising		1.199	1.23	1.261	V
CURRENT LIMIT           V <sub>IN</sub> = 12V         R <sub>CB</sub> = 41.2kΩ         6         6.6         7.2           R <sub>CB</sub> = 10.5kΩ         1.2         1.43         1.66           A         A         A           Circuit-Breaker Accuracy (Note 2)         I <sub>CB</sub> _TH         V <sub>IN</sub> = 3.3V, T <sub>A</sub> = 85°C (Note 3, 4)         R <sub>CB</sub> = 46.4kΩ         7.0         7.7         8.4           Circuit-Breaker Accuracy Deviation (Note 4)         R <sub>CB</sub> = 10.5kΩ to 21.5kΩ, compared to nominal current-limit value, V <sub>IN</sub> = V <sub>CC</sub> = 2.7 v to 12V         -16         +16         +16           R <sub>CB</sub> = 21.5kΩ to 41.2kΩ, compared to nominal current-limit value         -10         +10         +16           Slow-Comparator Response Time (Note 5)         t <sub>SCD</sub> 0.6% overcurrent         2.7         ms           CB Source Current         I <sub>THCB_NORM</sub> In power-on mode         12         μA           Maximum Current Limit During         I <sub>LIM</sub> (see Figure 2)         0.5 x (CB_TH)         1.5 x (CB_TH)         A           Fast-Comparator Threshold         IFC_TH         1.5 x (CB_TH)         A         A           Fast-Comparator Response Time         t <sub>FCD</sub> R <sub>TIMER</sub> = open         2000         ns           Additional Delay Time by TIMER         t <sub>AFCD</sub> R <sub>TIMER</sub> = open	OV Turn-On Threshold Hysteresis	V <sub>OV_HYS</sub>	V <sub>UVOV</sub> falling			50		mV
Circuit-Breaker Accuracy (Note 2)   I <sub>CB_TH</sub>   V <sub>IN</sub> = 12V   R <sub>CB</sub> = 41.2kΩ   6   6.6   7.2   R <sub>CB</sub> = 10.5kΩ   1.2   1.43   1.66   A   A   A   A   A   A   A   A   A	OVUV Input Leakage Current	I <sub>LEAK</sub>	V <sub>UVOV</sub> = V <sub>EN</sub> =	0V to 5.5V	-1		+1	μA
Vin = 12V   RCB = 10.5kΩ   1.2   1.43   1.66   A	CURRENT LIMIT							
Circuit-Breaker Accuracy (Note 2)   ICB_TH   VIN = 3.3V, TA = 8.5°C (Note 3.4)   VIN = 3.3V, TA = 8.5°C (Note 3.4)   RCB = 10.5kΩ 0   7.0   7.7   8.4   A			\/ = 12\/	$R_{CB} = 41.2k\Omega$	6	6.6	7.2	
$ \begin{array}{c} V_{NA} = 35^{\circ}C \\ (Note 3, 4) \end{array} \\ \hline V_{A} = 85^{\circ}C \\ (Note 3, 4) \end{array} \\ \hline R_{CB} = 10.5 k\Omega \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $			VIN - 12V	$R_{CB} = 10.5k\Omega$	1.2	1.43	1.66	
$ \frac{\text{nominal current-limit value, } V_{\text{IN}} = V_{\text{CC}}}{2.7V \text{ to } 12V} - 16 \\ = 2.7V \text{ to } 12V \\ \hline \text{R}_{\text{CB}} = 21.5 \text{k}\Omega \text{ to } 41.2 \text{k}\Omega, \text{ compared to nominal current-limit value}} \\ -10 \\ \hline \text{Slow-Comparator Response Time (Note 5)} \\ \hline \text{Slow-Comparator Response Time (Note 5)} \\ \hline \text{CB Source Current} \\ \hline \text{ITHCB\_NORM} \\ \hline \text{ITHCB\_NORM} \\ \hline \text{IN power-on mode} \\ \hline \text{ILIM} \\ \hline \text{Startup} \\ \hline \text{Maximum Current-Limit During} \\ \hline \text{Startup} \\ \hline \text{ILIM} \\ \hline \text{Fast-Comparator Threshold} \\ \hline \text{IFC\_TH} \\ \hline \text{IFC\_TH} \\ \hline \text{IFC\_TH} \\ \hline \text{In power-on mode} \\ \hline In power-o$	Circuit-Breaker Accuracy (Note 2)	Ісв_тн	T <sub>A</sub> = 85°C	$R_{CB} = 46.4k\Omega$	7.0	7.7	8.4	A
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Circuit-Breaker Accuracy Deviation		nominal current-		-16		+16	%
SCD   30% overcurrent   200   μs	(Note +)		""	•	-10		+10	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Slow-Comparator Response Time	t	0.6% overcurren	t		2.7		ms
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	(Note 5)	<sup>1</sup> SCD	30% overcurrent			200		μs
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	CB Source Current	I <sub>THCB_NORM</sub>	In power-on mod	le		12		μA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Maximum Current Limit During Startup	I <sub>LIM</sub>	(see Figure 2)					А
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Fast-Comparator Threshold	I <sub>FC_TH</sub>				1.5 x		А
Minimum CB Voltage Reference During Foldback (Note 6)VTHCB_MINVIN - VOUT > 10V, RCB = 41.2kΩ60mVMaximum CB Voltage Reference During Foldback (Note 6)VTHCB_MAXVIN - VOUT < 2V, RCB = 41.2kΩ	Fast-Comparator Response Time	t <sub>FCD</sub>						ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Additional Delay Time by TIMER	t <sub>AFCD</sub>	R <sub>TIMER</sub> = open			2		μs
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Minimum CB Voltage Reference During Foldback (Note 6)	V <sub>THCB_MIN</sub>	V <sub>IN</sub> - V <sub>OUT</sub> > 10	V, R <sub>CB</sub> = 41.2kΩ		60		mV
	Maximum CB Voltage Reference During Foldback (Note 6)	V <sub>THCB_MAX</sub>	V <sub>IN</sub> - V <sub>OUT</sub> < 2V	, R <sub>CB</sub> = 41.2kΩ		250		mV
Autoretry Delay Time $t_{RESTART}$ MAX15095A and MAX15095D only 3.4 s  Output Short Detection at Startup $t_{SHORT}$ 10.4 13.2 15.6 ms  MOSFET  Total On-Resistance $R_{ON}$ $T_{A} = +25^{\circ}\text{C}, \ l_{OUT} = 0.5\text{A}$ 10.6 14.3 $T_{A} = -40^{\circ}\text{C} \text{ to} +105^{\circ}\text{C}, \ l_{OUT} = 0.5\text{A}$ 18 $T_{A} = +70^{\circ}\text{C}, \ v_{IN} = 3.3\text{V}, \ l_{OUT} = 4\text{A}}$ 18	TIMING							
	Startup Maximum Time Duration	t <sub>SU</sub>			43	52	61	ms
	Autoretry Delay Time	t <sub>RESTART</sub>	MAX15095A and MAX15095D only			3.4		S
$ {\rm T_{A} = +25^{\circ}C, \ I_{OUT} = 0.5A}                                    $	Output Short Detection at Startup	tshort			10.4	13.2	15.6	ms
Total On-Resistance $R_{ON} = \frac{T_{A} = -40^{\circ}\text{C to } +105^{\circ}\text{C}, \ I_{OUT} = 0.5\text{A}}{T_{A} = +70^{\circ}\text{C}, \ V_{IN} = 3.3\text{V}, \ I_{OUT} = 4\text{A}}{(\text{Note 4})} $	MOSFET							
T <sub>A</sub> = +70°C, V <sub>IN</sub> = 3.3V, I <sub>OUT</sub> = 4A (Note 4) 18			T <sub>A</sub> = +25°C, I <sub>OU</sub>	T = 0.5A		10.6	14.3	
$T_A = +70^{\circ}\text{C}, V_{\text{IN}} = 3.3\text{V}, I_{\text{OUT}} = 4\text{A}$ (Note 4)	Total On-Resistance	Row	$T_A = -40^{\circ}C \text{ to } +1$	05°C, I <sub>OUT</sub> = 0.5A			18	mO.
GATE Charge Current I <sub>GATE</sub> 4.8 5.9 7.1 µA	iodi on resistante	I VON		= 3.3V, I <sub>OUT</sub> = 4A			18	11122
	GATE Charge Current	I <sub>GATE</sub>			4.8	5.9	7.1	μA

#### **Electrical Characteristics (continued)**

 $(V_{IN} = V_{CC} = 2.7V \text{ to } 18V, T_A = T_J = -40^{\circ}\text{C} \text{ to } +105^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at  $V_{IN} = 12V$ ,  $R_{CB} = 10.5k\Omega$ , and  $T_A = +25^{\circ}\text{C}$ .) (Note 1)

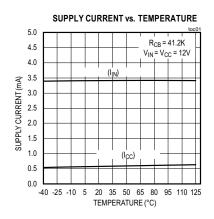
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
OUTPUTS							
PG Output Low Voltage	V <sub>OL</sub>	Low-impedance state, I <sub>PG</sub> = +5mA			0.4	V	
PG Output High-Leakage Current	Іон	High-impedance state, V <sub>PG</sub> = 16V			1	μA	
DISCHARGE	DISCHARGE						
D: 1 0 1A5 DO		V <sub>OUT</sub> < 7.1V (MAX15095D only)	50	100	160		
Discharge Current After PG Deasserted	I <sub>DISCHARGE</sub>	V <sub>OUT</sub> ≥ 7.1V to 18V (MAX15095D only)		710mW/ V <sub>OUT</sub>		mA	
PG THRESHOLD							
PG Threshold	V <sub>PG</sub>	V <sub>IN</sub> = 12V		0.9 x V <sub>IN</sub>		V	
PG Assertion Delay	t <sub>PG</sub>	From $V_{OUT} > V_{PG}$ and $V_{GATE} - V_{OUT} > 3V$	12	16	20	ms	
OUT-to-IN Short-Circuit Detection Threshold	V <sub>IOSHT</sub>	Measured at V <sub>OUT</sub>		0.9 x V <sub>IN</sub>		V	
OUT Preload Threshold	V <sub>PL</sub>	Measured at V <sub>OUT</sub>		0.5 x V <sub>IN</sub>		V	
INPUTS	•						
Input Logic Threshold EN	V <sub>EN_TH</sub>	Rising	0.95	1	1.05	V	
Threshold Hysteresis EN	V <sub>EN_TH_HYS</sub>	Falling		50		mV	
Input Logic Threshold PRSNT	V <sub>PRSNT</sub> _TH	Falling	0.92	0.97	1.02	V	
Threshold Hysteresis PRSNT	V <sub>PRSNT</sub> _TH_HYS	Rising		50		mV	
EN Bias Current	I <sub>EN_BIAS</sub>	V <sub>EN</sub> = 0 or 5.5V			1	μA	
PRSNT Input Bias Current	I <sub>PRSNT_</sub> BIAS	V <sub>PRSNT</sub> = 0 or 18V			1	μA	
EN Deglitch Time	t <sub>EN_DEG</sub>			100		μs	
PRSNT High-to-Low Deglitch Time	t <sub>PRSNT_</sub> DEG			400		μs	
THERMAL SHUTDOWN							
Thermal Shutdown	TSD	T <sub>J</sub> rising		145		°C	
Thermal Shutdown Hysteresis		T <sub>J</sub> falling		125		°C	

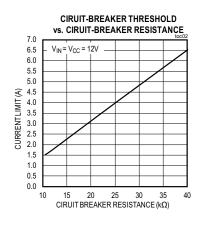
- Note 1: All devices are 100% production tested at  $T_A = +25$ °C. Limits over temperature are guaranteed by design.
- Note 2:  $41.2k\Omega$  is the maximum allowed external resistance value to be connected at the CB pin to GND for safe operation over the full 2.7V to 18V V<sub>IN</sub> range. The parameter specified at R<sub>CB</sub> =  $41.2k\Omega$  is guaranteed by bench characterization and correlation, with respect to the tested parameter at R<sub>CB</sub> =  $10.5k\Omega$ . The formula that describes the relationship between R<sub>CB</sub> and the circuit-breaker current threshold is: I<sub>CB</sub> = (R<sub>CB</sub>/5920) (V<sub>IN</sub>/33).
- Note 3: The CB resistance can be increased to 46.4kΩ if V<sub>IN</sub> is between 2.7V and 3.6V, with operating current of 6.6A for no longer than 500ms. Do not exceed 6A continuous current.
- Note 4: Guaranteed by design and not production tested.
- **Note 5:** The current-limit slow-comparator response time is weighed against the amount of overcurrent so the higher the overcurrent condition, the faster the response time.
- Note 6: Foldback is active during the startup phase so the internal power MOSFET operates within SOA.

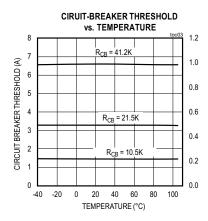
## 2.7V to 18V, 6.6A Integrated Hot-Swap/ **Electronic Circuit Breaker**

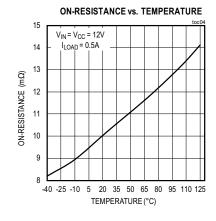
#### **Typical Operating Characteristics**

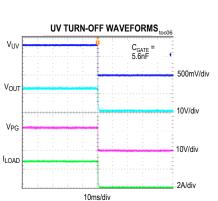
 $(V_{IN} = V_{CC} = 2.7V \text{ to } 18V, T_A = T_J = -40^{\circ}\text{C to } +85^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at } V_{IN} = 12V, R_{CB} = 10.5k\Omega, \text{ and } T_A = +25^{\circ}\text{C.})$ 

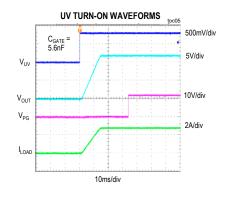


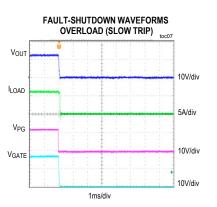








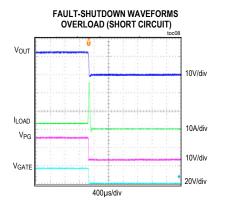


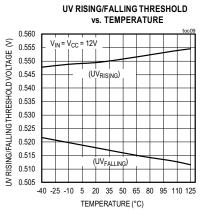


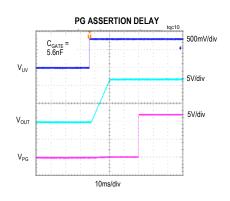
## 2.7V to 18V, 6.6A Integrated Hot-Swap/ **Electronic Circuit Breaker**

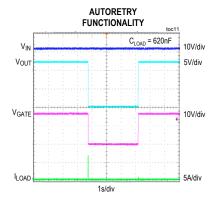
### **Typical Operating Characteristics (continued)**

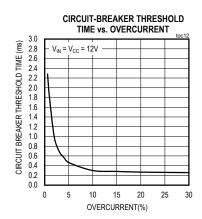
 $(V_{IN} = V_{CC} = 2.7V \text{ to } 18V, T_A = T_J = -40^{\circ}\text{C to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at  $V_{IN} = 12V, R_{CB} = 10.5k\Omega$ , and  $T_A = +25^{\circ}\text{C}$ .)

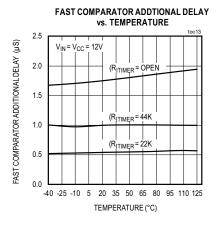


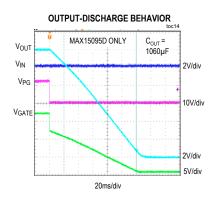






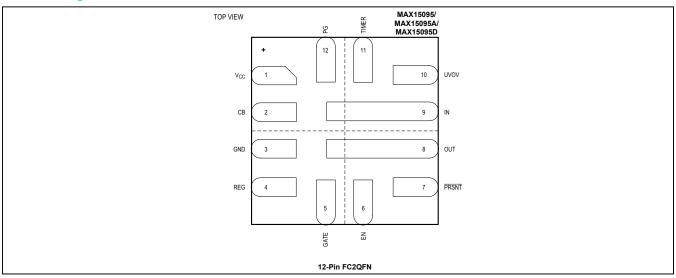






# 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

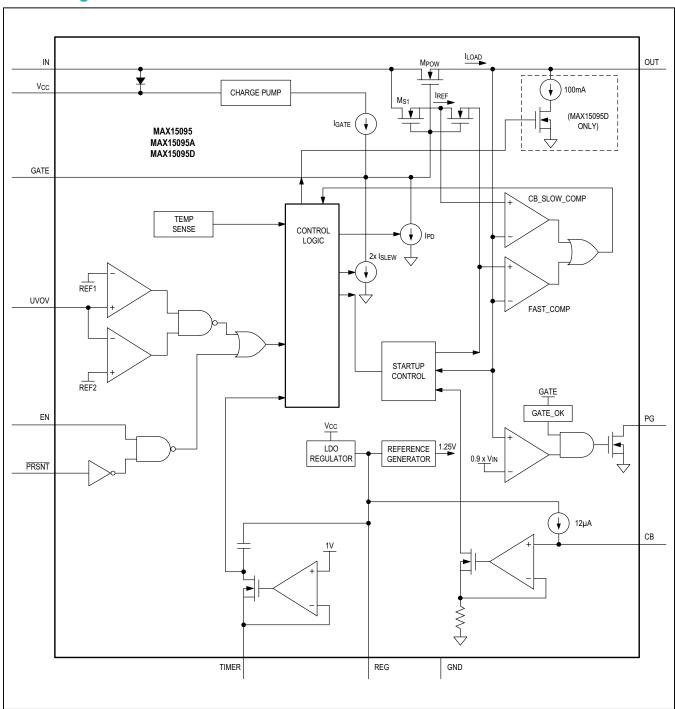
# **Pin Configuration**



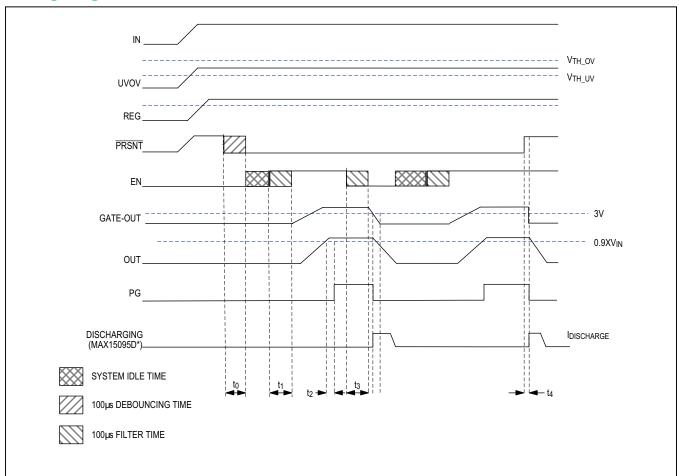
## **Pin Description**

PIN	NAME	FUNCTION
1	Vcc	Power-Supply Input. Connect $V_{CC}$ to a voltage between 2.7V and 18V. Connect a Schottky diode (or $10\Omega$ resistor) from IN to $V_{CC}$ , and a $1\mu F$ bypass capacitor to GND to guarantee full operation in the event $V_{IN}$ collapses during a strong short from OUT to GND.
2	СВ	Current-Limit Threshold Set. Connect a resistor from CB to GND to set the circuit-breaker threshold. Having the CB pin connected to GND sets the circuit- breaker threshold at 0A.
3	GND	Ground
4	REG	Internal Regulator Output. Bypass to ground with a 1µF capacitor. Do not power external circuitry using the REG output.
5	GATE	Gate of Internal MOSFET. During startup, a 5.9µA (typ) current is sourced to enhance the internal MOSFET with a 10V/ms slew rate. Connect an external capacitance from GATE to GND to reduce the output slew rate during startup.
6	EN	Active-High Enable Comparator Input. Pulling EN high enables the output if PRSNT is held low.
7	PRSNT	Active-Low Present-Detect Logic Input. Pulling PRSNT to GND enables the output if EN is high.
8	OUT	Load Output. Source of the internal power MOSFET.
9	IN	Supply Voltage Input. IN is connected to the drain of the internal $10.6m\Omega$ (typ) MOSFET. Bypass IN with a transient voltage-suppressor diode to GND for clamping inductive kick transients in the case of fast output short circuit to GND.
10	UVOV	Undervoltage and Overvoltage Threshold Pin. UVOV sets the under/overvoltage threshold.
11	TIMER	Timing Input. Connect a resistor from TIMER to GND to program the maximum time the part is allowed to remain in current limit. See the <i>TIMER</i> section. If TIMER is not connected, the parasitic capacitance between TIMER and GND must be less than 10pF.
12	PG	Power-Good Output. PG is an open-drain output. Connect to an external pullup resistor to make it an active-high output. PG pulls low until the internal power MOSFET is fully enhanced.

## **Block Diagram**



# **Timing Diagram**



### **Table 1. Timing**

TIMING PARAMETER	MIN	TYP	MAX	UNITS
t <sub>0</sub>	_	400	_	μs
t <sub>1</sub>	_	100	_	μs
t <sub>2</sub>	12	16	20	ms
t <sub>3</sub>	_	100	_	μs
t <sub>4</sub>	_	0.5	_	μs

### 2.7V to 18V, 6.6A Integrated Hot-Swap/ **Electronic Circuit Breaker**

#### **Detailed Description**

#### **Enable Logic and Undervoltage/** Overvoltage-Lockout Threshold

The supply output can become active only after all the following events have occurred:

- IN is within the UVOV window
- V<sub>CC</sub> is above its UVLO threshold
- EN meets its enable threshold for more than 100us
- PRSNT is low for more than 400µs

The MAX15095 family of devices enables the outputs as shown in Table 1. The devices are ready to drive the output when the V<sub>CC</sub> supply rises above the V<sub>UVLO</sub> threshold. The devices turn on the output when  $V_{CC}$  > V<sub>UVLO</sub>, V<sub>UVOV</sub> is higher than 0.55V (V<sub>UV</sub> <sub>TH</sub>) and less than 1.23V (VOV TH). The devices turn off the output when V<sub>UVOV</sub> falls below (0.55V - V<sub>UV HYS</sub>) or V<sub>UVOV</sub> rises above 1.23V. An external resistive divider (as shown in Figure 1) from IN to UVOV and ground provide the flexibility to select the undervoltage/overvoltage-lockout threshold to the desired value. Set the UVOV threshold using the following equations:

$$UVP = 0.55(R1 + R2) / R2$$
  
 $OVP = 1.23(R1 + R2) / R2$ 

#### Startup

Once the devices' output is enabled, the device provides controlled application of power to the load. The voltage at OUT begins to rise at approximately 10V/ms default until the programmed circuit-breaker current level is reached, while the devices actively limit the inrush current at the circuit-breaker setting. An external capacitance connected to the GATE pin allows the user to program the slew rate to a value lower than the default. The inrush current can be programmed by appropriate selection of RCB. During startup, a foldback current limit is active to protect the internal MOSFET to operate within a safe operating area. (Figure 2).

**Table 2. Output-Enable Truth Table** 

POWER SUPPLY	PRECISION AN	PRECISION ANALOG INPUT		
V <sub>CC</sub> UVLO	UVP	UVP OVP		
V <sub>CC</sub> > V <sub>UVLO</sub>	V <sub>UVOV</sub> > V <sub>UV_TH</sub>	V <sub>UVOV</sub> < V <sub>OV_TH</sub>	On	
V <sub>CC</sub> < V <sub>UVLO</sub>	X	X	Off	
X	V <sub>UVOV</sub> < (V <sub>UV_TH</sub> - V <sub>UV_HYS</sub> )	X	Off	
X	X	V <sub>UVOV</sub> > V <sub>OV</sub> TH	Off	

X = Don't care.

 $V_{UV}$   $T_H = 0.55V$  (typ).

 $V_{OV}$  TH = 1.23V (typ).

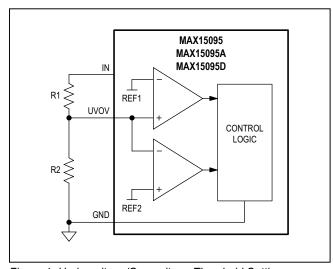


Figure 1. Undervoltage/Overvoltage Threshold Setting

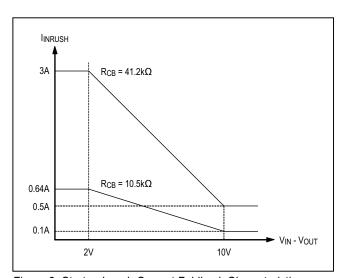


Figure 2. Startup Inrush Current Foldback Characteristics

### 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

An internal 52ms (typ) timer starts counting when the device enters a startup phase. The devices complete the startup phase and enter normal operation mode if the voltage at OUT rises above the preload threshold (0.9 x  $V_{IN}$ ) and ( $V_{GATE}$  -  $V_{OUT}$ ) > 3V. An open-drain power-good output (PG) goes high impedance 16ms after the startup successfully completes. The thermal-protection circuit is always active and the internal MOSFET is immediately turned off so a thermal-shutdown threshold condition can be reached.

If the startup is not successful because the output is shorted or the load is too high (OUT voltage < 1V), the devices turn off the hot-swap switch after the output short detection at startup  $t_{SHORT}$  (13.2ms) elapses.

#### VariableSpeed/BiLevel-Fault Protection

VariableSpeed/BiLevel-fault protection incorporates comparators with different thresholds and response times to monitor the load current (Figure 3). Protection is provided in normal operation (after the startup period has expired) by discharging the MOSFET gate in response to a fault condition. During a fault condition, the MAX15095A enters an autoretry mode while the MAX15095 latches off (see the *Autoretry and Latchoff-Fault Management* section).

#### **Enable Input (EN)**

The devices allow for enabling the MOSFET in an activehigh configuration. When all other enabling conditions are verified and the EN pin is at a logic-high level, the MOSFET is enabled. Similarly, when the EN pin is at a logic-low level, the MOSFET is disabled.

#### **Charge Pump**

An integrated charge pump provides the gate-drive voltage for the internal power MOSFET. The charge pump generates the proper gate-drive voltage above  $V_{IN}$  to fully enhance the internal power MOSFET and guarantee low  $R_{ON}$  operation during normal-state condition.

During startup, the internal charge pump drives the GATE of the MOSFET with a fixed 5.9 $\mu$ A current to enhance the internal MOSFET with 10V/ms (typ) slew rate. To reduce the output slew rate during startup below 10V/ms, connect an external capacitor (C<sub>GATE</sub>) from GATE to GND. The value of C<sub>GATE</sub> is determined according to the equation:

where  $I_{GATE}$  is 5.9µA (typ),  $t_{ON}$  is the desired output ramp-up time, and  $V_{OUT}$  is the final output voltage.

The slew rate of the OUT pin during startup is controlled by I<sub>GATE</sub>/C<sub>GATE</sub> under light-load conditions, but under heavier load, the foldback current limit and the external capacitive load will determine the actual slew rate.

$$(\Delta V_{OUT}/\Delta t) = (I_{LIM} - I_{LOAD})/C_{LOAD}$$

where I<sub>LIM</sub> represents the voltage-dependent foldback current limit. See <u>Electrical Characteristics</u>.table and <u>Figure 3</u>. The load current is subtracted from I<sub>LIM</sub>, because any current consumed by the load does not help charge the output capacitance.

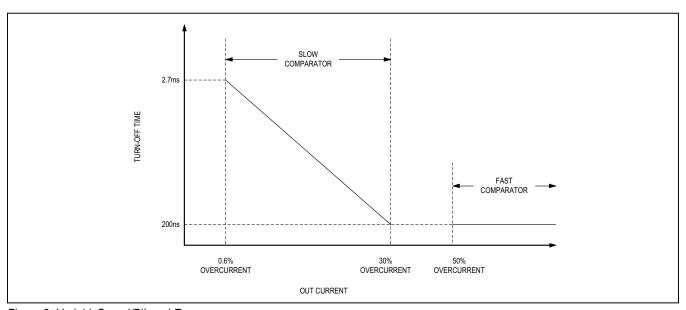


Figure 3. VariableSpeed/BiLevel Response

### 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

#### **Circuit-Breaker Comparator and Current Limit**

The current through the internal power MOSFET is compared to a circuit-breaker threshold. An external resistor between CB and ground sets this threshold according to the following formula:

$$I_{CB}(A) = (R_{CB} / 5920) - (V_{IN} / 33)$$

where R<sub>CB</sub> is the resistor between CB and ground.

The circuit-breaker comparator is designed so that the load current can exceed the threshold for some amount of time before tripping. The time delay varies inversely with the overdrive above the threshold. The greater the overcurrent condition, the faster the response time, allowing the devices to tolerate load transients and noise near the circuit-breaker threshold. The operating current should not be allowed to exceed 6.6A for longer than 500ms. The maximum allowed external resistor value is  $46.4 \mathrm{k}\Omega$ .

The devices also feature catastrophic short-circuit protection. During normal operation, if OUT is shorted directly to ground, a fast protection circuit forces the gate of the internal MOSFET to discharge quickly and disconnect the output from the input.

#### **Autoretry and Latchoff-Fault Management**

During a fault condition, the devices turn off the internal MOSFET, disconnecting the output from the input. The MAX15095A enters an autoretry mode and restarts after t<sub>RESTART</sub> (3.4s typ) time delay elapses.

The MAX15095 latches off and remains off until the enable logic is cycled off and on after a certain delay. The delay prevents the latchoff device from restarting and operating with an unsafe power-dissipation duty cycle. See the *Timing Diagram* and Table 1 for delay values.

#### **Latchoff Reset**

The latchoff could be reset if any one of the following happens:

- V<sub>CC</sub> is below its UVLO threshold
- EN is disabled for longer than 100µs
- UV is triggered
- PRSNT goes above its threshold
- OV is triggered

#### Power-Good (PG) Delay

The devices feature an open-drain, power-good output that asserts after  $t_{PG}$  delay, indicating that OUT voltage has reached (0.9 x  $V_{IN}$ ) voltage and ( $V_{GATE}$  -  $V_{OUT}$ ) > 3V.

#### **REG**

The devices include a linear regulator that outputs 3.3V at REG. REG provides power to the internal circuit blocks of the devices and must not be loaded externally (except a resistor >  $50k\Omega$  connected from REG to EN). REG requires a 1µF capacitor to ground for proper operation.

#### **Output Discharging**

The discharge FET is active when the output is disabled or under fault event. In this event, the hot-swap is off and the output is on the way down. The discharging is triggered after the main FET has completely turned off.

The maximum output capacitance is approximately  $1000\mu F$ . The voltage could be up to 18V. Ideally, it discharges the output capacitor in constant-power mode (710mW typ) to ensure the voltage rail is below 0.3V within 2s or less.

#### TIMER

Connect a resistor from the TIMER pin to the GND pin to program the fast-trip response time. This time is the sum of the internal fast-comparator propagation delay (less than 200ns typ) plus an additional delay set by the external resistor connected from TIMER to ground. Choosing different resistance values, it is possible to change the value of additional delay. If the TIMER pin is connected to REG, the total response time is less than 200ns (typ).

Additional delay is disabled also during the startup phase or after a short-circuit event ( $V_{OUT}$  < 90%  $V_{IN}$ ). Be careful about additional delay settings related to a short event.

Additional delay can be calculated using the following formula:

Additional\_Delay ( $\mu$ s) = R<sub>TIMER</sub> ( $k\Omega$ ) x 22.9E-03 Maximum additional delay time is set to 2 $\mu$ s. <u>Table 3</u> provides additional delay settings.

**Table 3. Additional Delay Settings** 

OPTION	R <sub>TIMER</sub> (kΩ)	RESPONSE TIME (µs)
1	Open	2
2	86.6	2
3	43.2	1
4	21.5	0.5
5	11	0.25
6	0	0.050

## 2.7V to 18V, 6.6A Integrated Hot-Swap/ Electronic Circuit Breaker

#### **Thermal Protection**

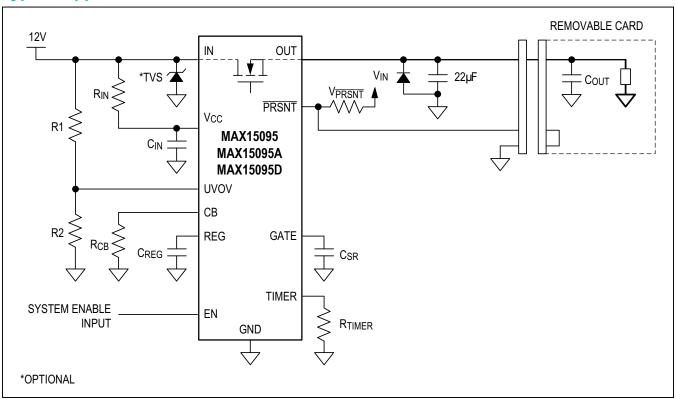
The devices enter a thermal shutdown mode in the event of overheating caused by excessive power dissipation or high ambient temperature. When the junction temperature exceeds  $T_J = 145^{\circ}\text{C}$  (typ), the internal thermal protection circuitry turns off the internal power MOSFET. The devices recover from thermal shutdown mode once the junction temperature drops by 20°C (typ).

#### **IN-to-OUT Short-Circuit Protection**

At startup, after all the input conditions are satisfied (UV, OV,  $V_{UVLO}$ ), the devices immediately check for IN-to-OUT short-circuit faults. If  $V_{OUT}$  is greater than 90% of  $V_{IN}$ , the internal MOSFET cannot be turned on, then the MAX15095A autoretries in  $t_{RESTART}$  (3.4s typ), while the MAX15095 latches off.

If  $V_{OUT}$  is in the range from 50% to 90% of  $V_{IN}$ , then the internal MOSFET still cannot be turned on after  $t_{SU}$  time elapses. The MAX15095A autoretries in  $t_{RESTART}$ , while the MAX15095 latches off.

### **Typical Application Circuit**



#### **Ordering Information**

PART	TEMP RANGE (°C)	PIN-PACKAGE	FAULT MANAGEMENT
MAX15095GFC+	-40 to +105	12 FC2QFN	Latchoff
MAX15095AGFC+	-40 to +105	12 FC2QFN	Autoretry
MAX15095DGFC+	-40 to +105	12 FC2QFN	Autoretry

<sup>+</sup>Denotes a lead (Pb)-free/RoHS-compliant package.

## **Chip Information**

PROCESS: BICMOS

## 2.7V to 18V, 6.6A Integrated Hot-Swap/ **Electronic Circuit Breaker**

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	2/18	Initial release	_
1	3/18	Updated TOC01–04, TOC09, and TOC13	5–6
2	4/19	Updated <i>Electrical Characteristics</i> table and the <i>EC Notes</i> section. Updated <i>Pin Description</i> table and the <i>Circuit-Breaker Comparator and Current Limit</i> section under the <i>Detailed Description</i>	3, 4, 7, 12
3	4/19	Corrected the Charge Pump section text and equations.	11
4	7/19	Corrected units for V <sub>CC</sub> Supply Current (I <sub>CC</sub> )	2

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